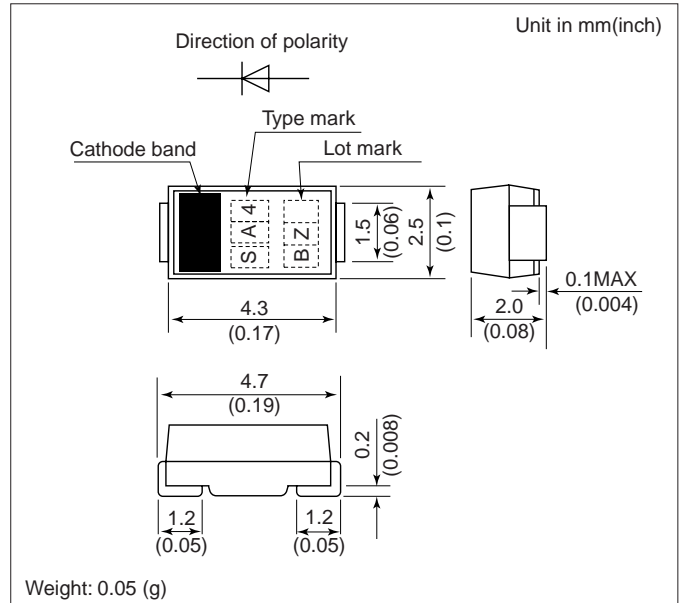


DSM1MA

FEATURES

- For general purpose
- High heat-resistant due to glass passivation.

OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS

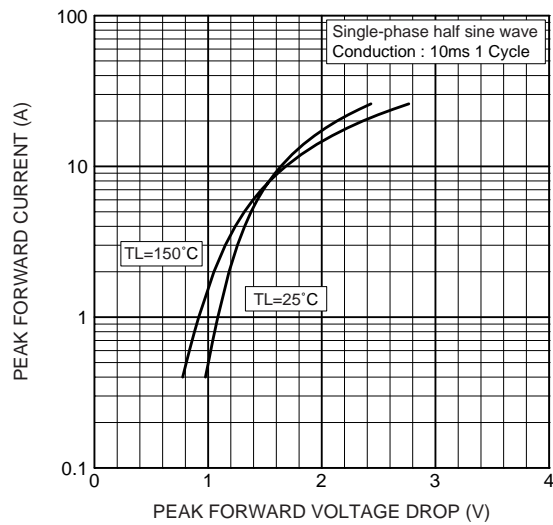
Items	Type		DSM1MA1	DSM1MA2	DSM1MA4
Repetitive Peak Reverse Voltage	V _{RRM}	V	100	200	400
Average Forward Current	I _{F(AV)}	A	1.0 (Single-phase half sine wave 180° conduction TL = 127°C)		
Surge(Non-Repetitive) Forward Current	I _{FSM}	A	25(Without PIV, 10ms, conduction Tj = 40°C start)		
I²t Limit Value	I²t	A²s	2.5(Time = 2 ~ 10ms, I = RMS value)		
Operating Junction Temperature	T _j	°C	-40 ~ +150		
Storage Temperature	T _{stg}	°C	-40 ~ +150		

CHARACTERISTICS(T_L=25°C)

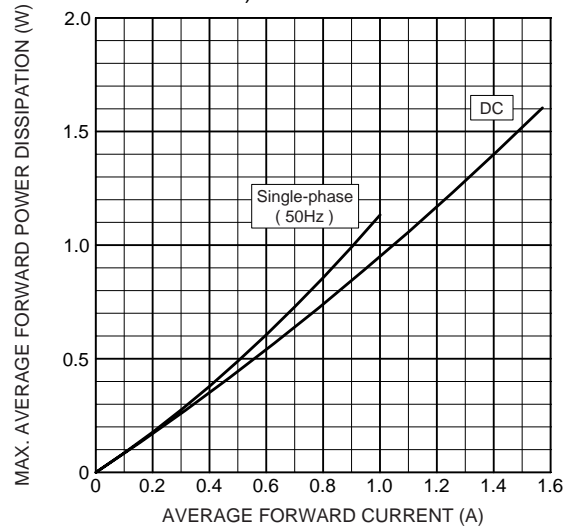
Items	Symbols	Units	Min.	Typ.	Max.	Test Conditions
Peak Reverse Current	I_{RRM}	μA	—	—	20	DSM1MA1,2 DSM1MA4 Rated V_{RRM}
					10	
Peak Forward Voltage	V_{FM}	V	—	—	1.1	$I_{FM}=1.0A$ p, Single-phase half sine wave 1 cycle
Steady State Thermal Impedance	$R_{th(j-a)}$	°C/W	—	—	120	On glass-epoxy substrate (□ 50mm) Soldering land (□ 6mm)
	$R_{th(j-l)}$				20	

DSM1MA

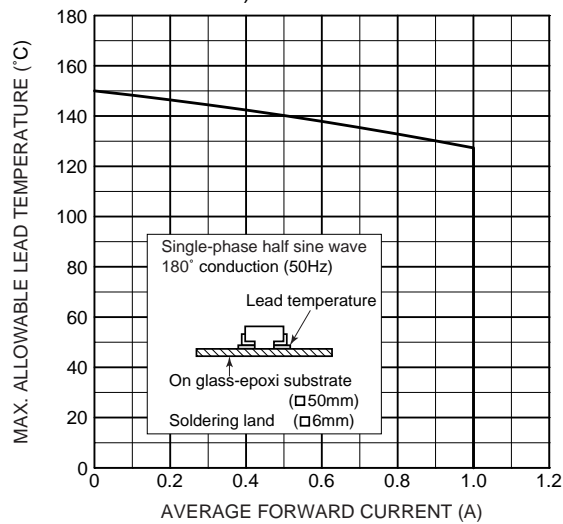
Forward characteristics



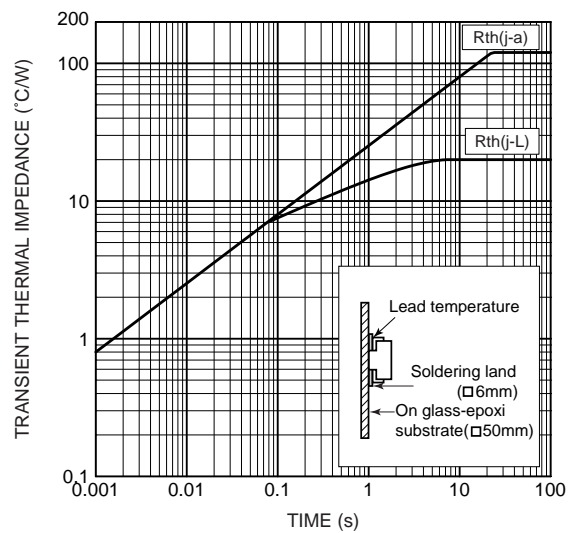
Max. average forward power dissipation
(Resistive or inductive load)



Max. allowable lead temperature
(Resistive or inductive load)



Transient thermal impedance



HITACHI POWER SEMICONDUCTORS

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